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## NC7NZ34 TinyLogic® UHS Triple Buffer

### General Description

The NC7NZ34 is a triple buffer from Fairchild's Ultra High Speed Series of TinyLogic® in the space saving US8 package. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65V to 5.5V  $V_{CC}$  range. The inputs and outputs are high impedance when  $V_{CC}$  is 0V. Inputs tolerate voltages up to 7V independent of  $V_{CC}$  operating voltage.

### Features

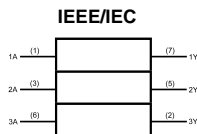
- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Ultra High Speed:  $t_{PD}$  2.4 ns Typ into 50 pF at 5V  $V_{CC}$
- High Output Drive:  $\pm 24$  mA at 3V  $V_{CC}$
- Broad  $V_{CC}$  Operating Range: 1.65V to 5.5V
- Power down high impedance inputs/outputs
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Proprietary noise/EMI reduction circuitry implemented

### Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7NZ34K8X	MAB08A	NZ34	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7NZ34L8X	MAC08A	P9	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

### Logic Symbol



### Pin Descriptions

Pin Names	Description
A <sub>1</sub> , A <sub>2</sub> , A <sub>3</sub>	Data Inputs
Y <sub>1</sub> , Y <sub>2</sub> , Y <sub>3</sub>	Output

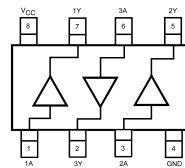
### Function Table

$$Y = A$$

Input	Output
A	Y
L	L
H	H

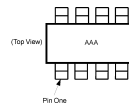
H = HIGH Logic Level  
L = LOW Logic Level

### Connection Diagrams



(Top View)

### Pin One Orientation Diagram

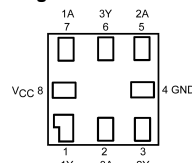


Pin One

AAA represents Product Code Top Mark - see ordering code

**Note:** Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

### Pad Assignments for MicroPak



(Top Thru View)

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MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

### Absolute Maximum Ratings (Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Input Voltage ( $V_{IN}$ )	-0.5V to +7.0V
DC Output Voltage ( $V_{OUT}$ )	-0.5V to +7.0V
DC Input Diode Current ( $I_{IK}$ )	
$V_{IN} < 0V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_{OUT} < 0V$	-50 mA
DC Output Source/Sink Current ( $I_{OUT}$ )	±50 mA
DC $V_{CC}/GND$ Current ( $I_{CC}/I_{GND}$ )	±100 mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Junction Temperature under Bias ( $T_J$ )	150°C
Junction Lead Temperature ( $T_L$ )	
(Soldering, 10 seconds)	260°C
Power Dissipation ( $P_D$ ) @ +85°C	250 mW

### Recommended Operating Conditions (Note 2)

Supply Voltage	
Operating ( $V_{CC}$ )	1.65V to 5.5V
Data Retention	1.5V to 5.5V
Input Voltage ( $V_{IN}$ )	0V to 5.5V
Output Voltage ( $V_{OUT}$ )	0V to $V_{CC}$
Input Rise and Fall Time ( $t_r, t_f$ )	
$V_{CC} = 1.8V, 2.5V \pm 0.2V$	0 to 20 ns/V
$V_{CC} = 3.3V \pm 0.3V$	0 to 10 ns/V
$V_{CC} = 5.5V \pm 0.5V$	0 to 5 ns/V
Operating Temperature ( $T_A$ )	-40°C to +85°C
Thermal Resistance ( $\theta_{JA}$ )	250°C/W

**Note 1:** Absolute maximum ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

**Note 2:** Unused inputs must be held HIGH or LOW. They may not float.

### DC Electrical Characteristics

Symbol	Parameter	$V_{CC}$ (V)	$T_A = +25^\circ\text{C}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions	
			Min	Typ	Max	Min	Max			
$V_{IH}$	HIGH Level Control Input Voltage	1.8 ± 0.15	0.75 $V_{CC}$			0.75 $V_{CC}$		V		
		2.3 to 5.5	0.7 $V_{CC}$			0.7 $V_{CC}$				
$V_{IL}$	LOW Level Control Input Voltage	1.8 ± 0.15	0.25 $V_{CC}$			0.25 $V_{CC}$		V		
		2.3 to 5.5	0.3 $V_{CC}$			0.3 $V_{CC}$				
$V_{OH}$	HIGH Level Control Output Voltage	1.65	1.55	1.65	1.55		V	$V_{IN} = V_{IH}$	$I_{OH} = -100 \mu\text{A}$	
		2.3	2.2	2.3	2.2					
		3.0	2.9	3.0	2.9					
		4.5	4.4	4.5	4.4					
		1.65	1.29	1.52	1.29				$I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$ $I_{OH} = -16 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -32 \text{ mA}$	
		2.3	1.9	2.14	1.9					
		3.0	2.4	2.75	2.4					
		3.0	2.3	2.62	2.3					
		4.5	3.8	4.13	3.8					
$V_{OL}$	LOW Level Control Output Voltage	1.65	0.0			0.1		V	$V_{IN} = V_{IL}$	$I_{OL} = 100 \mu\text{A}$
		2.3	0.0			0.1				
		3.0	0.0			0.1				
		4.5	0.0			0.1				
		1.65	0.08		0.24	0.24				$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$ $I_{OL} = 16 \text{ mA}$ $I_{OL} = 24 \text{ mA}$ $I_{OL} = 32 \text{ mA}$
		2.3	0.10		0.3	0.3				
		3.0	0.16		0.4	0.4				
		3.0	0.24		0.55	0.55				
		4.5	0.25		0.55	0.55				
$I_{IN}$	Input Leakage Current	0 to 5.5	±0.1			±1.0		μA	$0 \leq V_{IN} \leq 5.5V$	
$I_{OFF}$	Power Off Leakage Current	0.0				1.0		μA	$V_{IN}$ or $V_{OUT} = 5.5V$	
$I_{CC}$	Quiescent Supply Current	1.65 to 5.5				1.0		μA	$V_{IN} = 5.5V, GND$	

## AC Electrical Characteristics

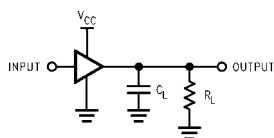
Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t <sub>PLH</sub>	Propagation Delay	1.8 ± 0.15	1.8	4.6	8.0	1.8	8.8	ns	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 1 MΩ	Figures 1, 3
t <sub>PHL</sub>		2.5 ± 0.2	1.0	3.0	5.2	1.0	5.8			
		3.3 ± 0.3	0.8	2.3	3.6	0.8	4.0			
		5.0 ± 0.5	0.5	1.8	2.9	0.5	3.2			
t <sub>PLH</sub>	Propagation Delay	3.3 ± 0.3	1.2	3.0	4.6	1.2	5.1	ns	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω	Figures 1, 3
t <sub>PHL</sub>		5.0 ± 0.5	0.8	2.4	3.8	0.8	4.2			
C <sub>IN</sub>	Input Capacitance	0	2.5					pF		
C <sub>PD</sub>	Power Dissipation	3.3	9					pF	(Note 3)	Figure 2
	Capacitance	5.0	11							

**Note 3:** C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  
I<sub>CCD</sub> = (C<sub>PD</sub>)(V<sub>CC</sub>)(f<sub>IN</sub>) + (I<sub>CC</sub>static).

## Dynamic Switching Characteristics

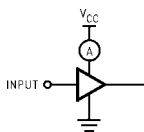
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C	Unit
				Typical	
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	C <sub>L</sub> = 50pF, V <sub>IH</sub> = 5.0V, V <sub>IL</sub> = 0V	5.0	0.8	V
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	C <sub>L</sub> = 50pF, V <sub>IH</sub> = 5.0V, V <sub>IL</sub> = 0V	5.0	-0.8	V

## AC Loading and Waveforms



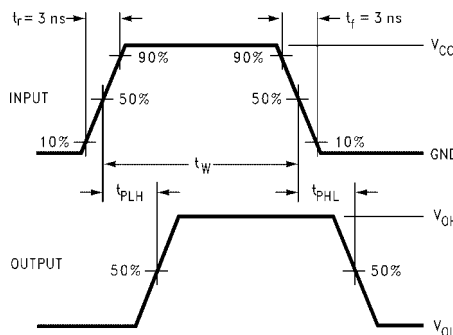
C<sub>L</sub> includes load and stray capacitance  
Input PRR = 1.0 MHz; t<sub>W</sub> = 500 ns

**FIGURE 1. AC Test Circuit**



Input = AC Waveform; t<sub>r</sub> = t<sub>f</sub> = 1.8 ns;  
PRR = 10 MHz; Duty Cycle = 50%

**FIGURE 2. I<sub>CCD</sub> Test Circuit**



**FIGURE 3. AC Waveforms**

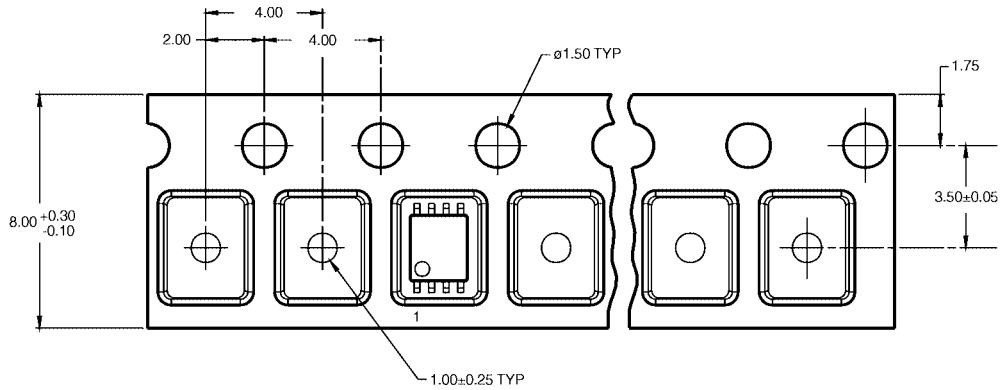
NC7NZ34

### Tape and Reel Specification

#### TAPE FORMAT for US8

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
K8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

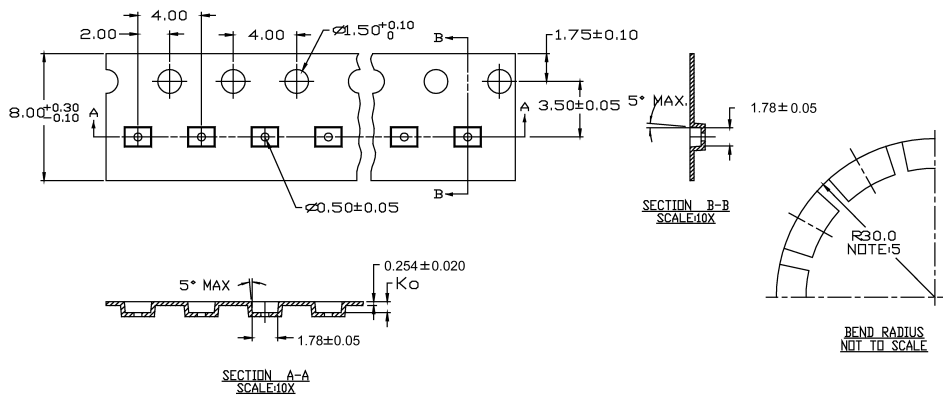
#### TAPE DIMENSIONS inches (millimeters)



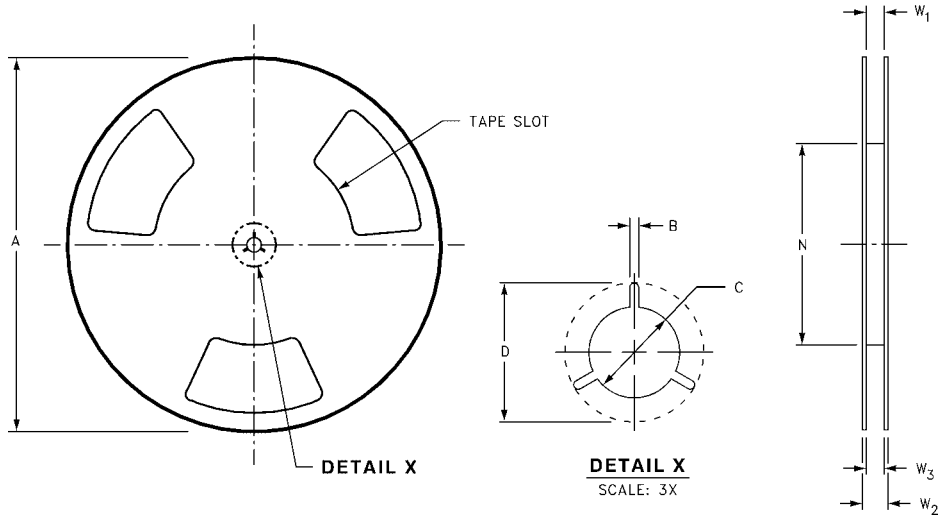
#### TAPE FORMAT for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
K8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

#### TAPE DIMENSIONS inches (millimeters)

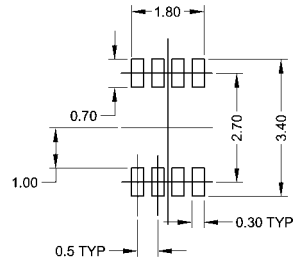
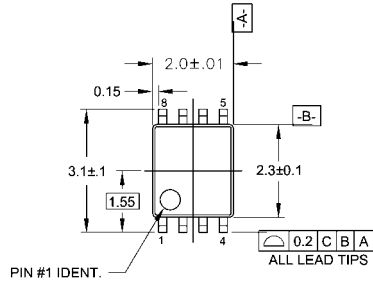


**Tape and Reel Specification** (Continued)  
**REEL DIMENSIONS** inches (millimeters)

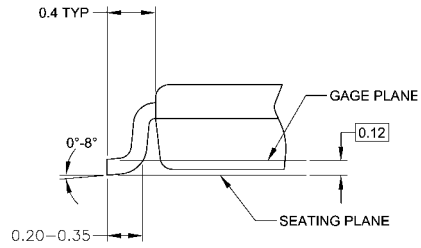
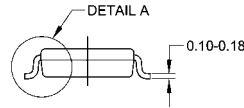
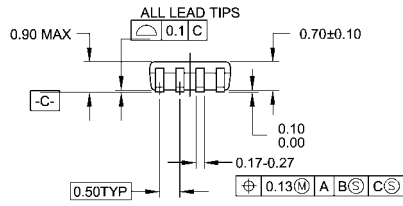


Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

**Physical Dimensions** inches (millimeters) unless otherwise noted



**LAND PATTERN RECOMMENDATION**



**DETAIL A**

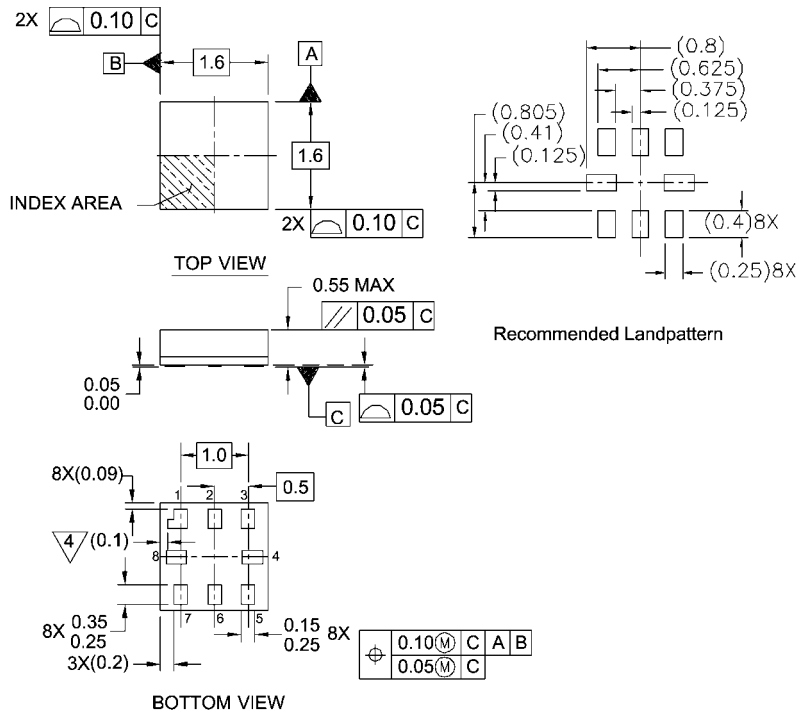
**NOTES:**

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

**8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide  
Package Number MAB08A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**Notes:**

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

**Pb-Free 8-Lead MicroPak, 1.6 mm Wide  
Package Number MAC08A**

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